



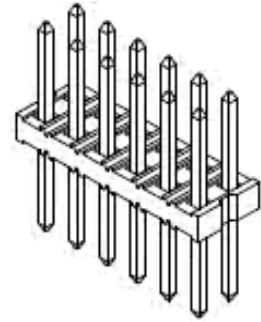
**Part Number :** [877580616](#)

**Product Description :** 2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 6 Circuits, 0.38µm Gold (Au) Selective Plating, Pocket Tray Packaging, Lead-Free

**Series Number :** 87758

**Status :** Active

**Product Category :** PCB Headers and Receptacles



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## Documents and Resources

### Drawings

[877580616 sd.pdf](#)

[PK-89990-487-001.pdf](#)

### 3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

[Symbol and Footprint \(Multi-Format\)](#)

### Specifications

[503940001-AS-000.pdf](#)


[PS-87761-100-001.pdf](#)

[877610000-TS-000.pdf](#)

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## Product Environment Compliance

### Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)6375-DC (05 Nov 2025) SCIP:a58ab0b4-

	d5f3-47ff-b9a7-26e8d01d8262
EU RoHS	Compliant per EU 2015/863

### Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

### Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

### Substances of Interest

- PFAS

### EU RoHS Certificate of Compliance

### Additional Product Compliance Information

## Part Details

### General

Status	Active
Category	PCB Headers and Receptacles
Series	87758
Description	2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 6 Circuits, 0.38µm Gold (Au) Selective Plating, Pocket Tray Packaging, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Header
Product Name	Milli-Grid
UPC	822348271313

### Agency

UL	E29179
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### Electrical

Current - Maximum per Contact	2.0A
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Voltage - Maximum	125V
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## Physical

Breakaway	Yes
Circuits (Loaded)	6
Circuits (maximum)	6
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Mated Height	4.00mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	0.152/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.60mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

## Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	250

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## Mates With / Use With

### Mates with Part(s)

Description	Part Number
Milli-Grid Dual Row Receptacle Housings	<u>51110</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>78787</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>78788</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79107</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79108</u>
Milli-Grid Top/Bottom Entry Surface Mount PCB Receptacles	<u>79109</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>87381</u>

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